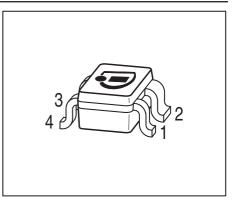


BFP183W

Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain broadband amplifiers at collector currents from 2 mA to 30 mA
- $f_{\rm T}$ = 8 GHz, $NF_{\rm min}$ = 0.9 dB at 900 MHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available







ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration						Package
BFP183W	RHs	1=E	2=C	3=E	4=B	-	-	SOT343

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	65	mA
Base current	I _B	5	
Total power dissipation ¹⁾	P _{tot}	450	mW
<i>T</i> _S ≤ 58 °C			
Junction temperature	TJ	150	°C
Storage temperature	T _{Sta}	-55 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	205	K/W

 ${}^{1}\mathcal{T}_{S}$ is measured on the collector lead at the soldering point to the pcb

²For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics				•	•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
<i>I</i> _C = 1 mA, <i>I</i> _B = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
V _{CE} = 20 V, V _{BE} = 0					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
V _{CB} = 10 V, <i>I</i> _E = 0					
Emitter-base cutoff current	/ _{EBO}	-	-	1	μA
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at T_A = 25 °C, unless otherwise specified



Parameter	Symbol		Values			
		min.	typ.	max.		
AC Characteristics (verified by random samplin	g)					
Transition frequency	f _T	6	8	-	GHz	
$I_{\rm C}$ = 25 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.34	0.54	pF	
$V_{\rm CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.27	-		
$V_{\rm CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\rm BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	1.1	-		
$V_{\rm EB}$ = 0.5 V, f = 1 MHz, $V_{\rm CB}$ = 0 ,						
collector grounded						
Minimum noise figure	NF _{min}				dB	
$I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	0.9	-		
<i>f</i> = 1.8 GHz		-	1.4	-		
Power gain, maximum stable ¹⁾	G _{ms}	-	22	-	dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 900 MHz						
Power gain, maximum available ¹⁾	G _{ma}	-	15.5	-	dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,						
<i>f</i> = 1.8 GHz						
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 15 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 900 MHz		-	17.5	-		
<i>f</i> = 1.8 GHz		-	11.5	-		

Electrical Characteristics at T_A = 25 °C, unless otherwise specified

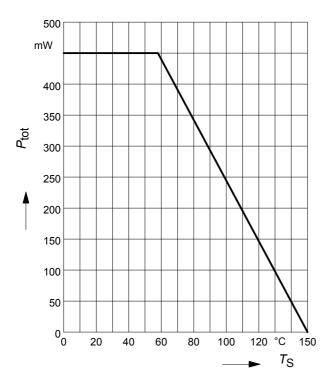
 ${}^{1}G_{\mathsf{ma}} = |S_{21\mathrm{e}} \: / \: S_{12\mathrm{e}}| \: (\mathsf{k}\text{-}(\mathsf{k}^2\text{-}1)^{1/2}), \: G_{\mathsf{ms}} = |S_{21} \: / \: S_{12}|$



BFP183W

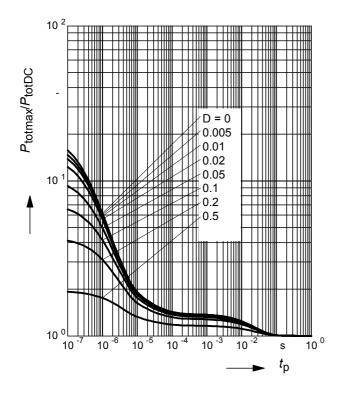
Total power dissipation $P_{tot} = f(T_S)$

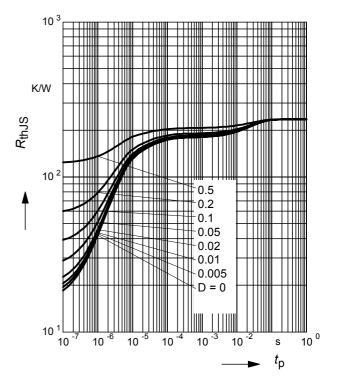
Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$



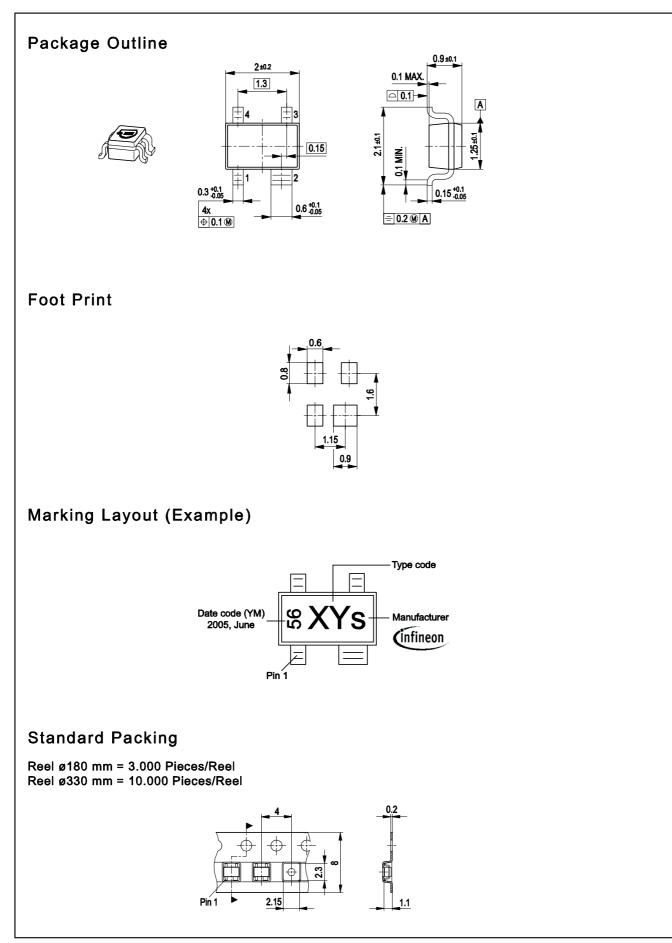
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$











Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<<u>www.infineon.com</u>>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered. 单击下面可查看定价,库存,交付和生命周期等信息

>>Infineon(英飞凌)